



### 60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>C</sub> = +25°C (Note 10)
60V	3.4mΩ @ V <sub>GS</sub> = 10V	100A

### **Description and Applications**

This MOSFET has been designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- **Engine Management Systems**
- **Body Control Electronics**
- DC-DC Converters

### **Features**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes Power Losses
- Low Q<sub>g</sub> Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

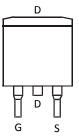
### **Mechanical Data**

- Case: TO263AB
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 1.7 grams (Approximate)

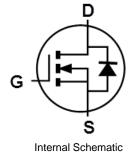
#### **TO263AB**



Top View



Pin Out Top View



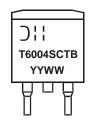
## Ordering Information (Note 5)

Part Number	Case	Packaging
DMTH6004SCTBQ-13	TO263AB	800 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive,
- For more information, please refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



T6004SCTB = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 15 = 2015) WW = Week (01 to 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	60	V	
Gate-Source Voltage	$V_{GSS}$	±20	V	
Continuous Drain Current (Note 7)	T <sub>C</sub> = +25°C (Note 10)	I <sub>D</sub>	100	А
, ,	$T_{C} = +100^{\circ}C$		100	
Maximum Continuous Body Diode Forward Current (Note 7)	T <sub>C</sub> = +25°C	Is	100	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle=1%)	I <sub>DM</sub>	200	Α	
Avalanche Current, L=0.2mH		I <sub>AS</sub>	45	Α
Avalanche Energy, L=0.2mH	E <sub>AS</sub>	200	mJ	

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	$T_A = +25$ °C	$P_{D}$	4.7	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{\theta JA}$	32	°C/W
Total Power Dissipation (Note 7)	$T_C = +25^{\circ}C$	$P_{D}$	136	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1.1	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +175	°C

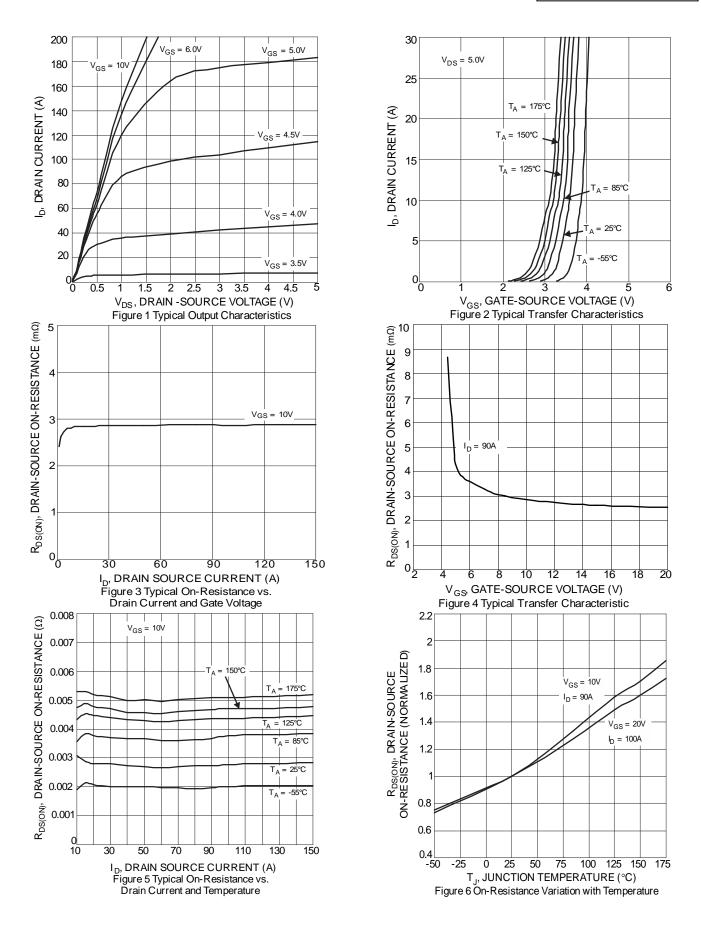
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
		_	_	1	μΑ	V <sub>DS</sub> = 48V, V <sub>GS</sub> = 0V	
Zero Gate Voltage Drain Current (Note 9)	I <sub>DSS</sub>	_	_	100	μA	V <sub>DS</sub> = 48V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125°C	
Gate-Source Leakage	I <sub>GSS</sub>		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)			•		•		
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	_	4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	2.9	3.4	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> =100A	
Diode Forward Voltage	$V_{SD}$	_	_	1.3	V	$V_{GS} = 0V, I_{S} = 100A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	1	4,556	_			
Output Capacitance	Coss	_	1,383	_	pF	$V_{DS} = 30V$ , $V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	105.2	_			
Gate Resistance	$R_g$	0.1	0.66	1.9	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	95.4	_		V 00V I 00A	
Gate-Source Charge	Qgs	_	21.6	_	nC	$V_{DD} = 30V, I_D = 90A,$	
Gate-Drain Charge	Q <sub>gd</sub>	_	20.4	_		V <sub>GS</sub> = 10V	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	13.2	_			
Turn-On Rise Time	t <sub>R</sub>	_	11.7	_		$V_{DD} = 30V, V_{GS} = 10V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	31	_	ns	$I_D = 90A, R_G = 3.5\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	12	_			
Reverse Recovery Time	t <sub>RR</sub>		50.5	_	ns	L 504 di/dt 4004/	
Reverse Recovery Charge	Q <sub>RR</sub>	1	80.8	_	nC	I <sub>F</sub> =50A, di/dt=100A/μs	

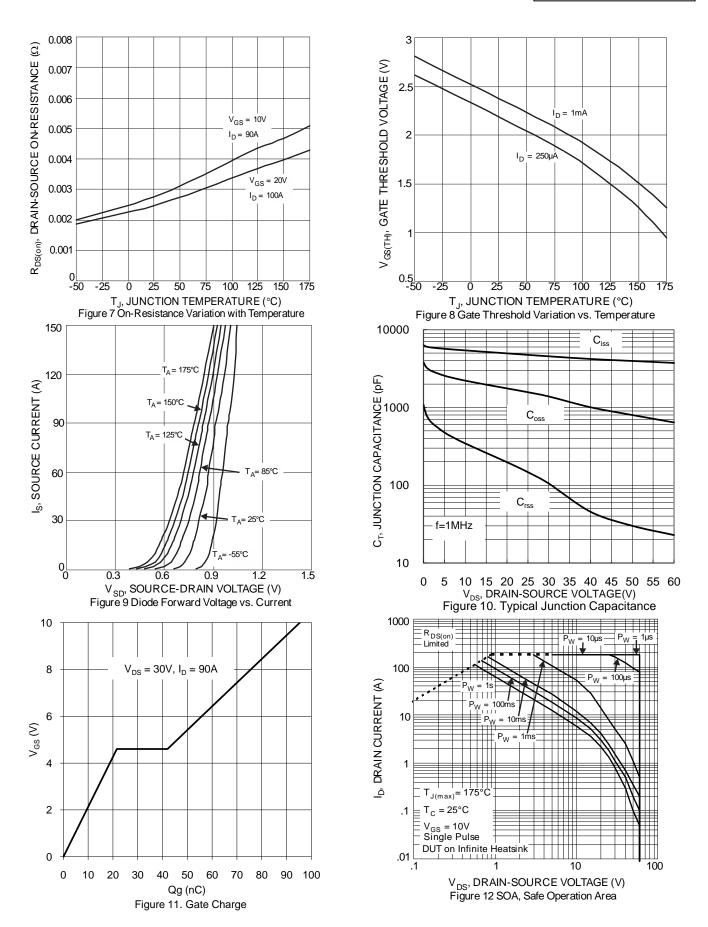
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.7. Thermal resistance from junction to soldering point (on the exposed drain pad).8. Short duration pulse test used to minimize self-heating effect.

Guaranteed by design. Not subject to product testing.
Package limited.

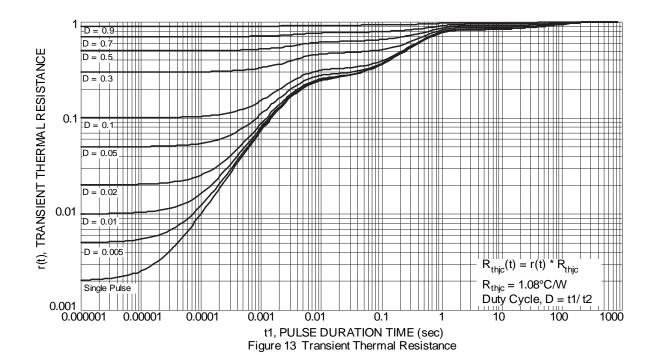










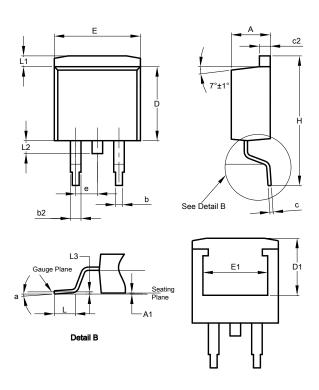




# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### TO263AB (D2PAK)

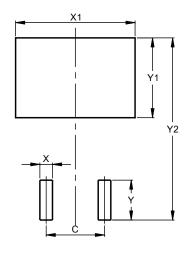


TO263AB (D2PAK)				
Dim	Min	Max	Тур	
Α	4.07	4.82	_	
A1	0.00	0.25	_	
b	0.51	0.99	_	
b2	1.15	1.77	_	
С	0.356	0.73	_	
c2	1.143	1.65	_	
D	8.39	9.65	_	
D1	6.55	6.95	_	
е	2.54 TYP			
E	9.66	10.66	_	
E1	6.23	8.23	_	
Н	14.61	15.87	_	
L	1.78	2.79	_	
L1	_	1.67	_	
L2	_	1.77	_	
L3	_	_	0.254	
а	0°	8°	_	
All Dimensions in mm				

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### TO263AB (D2PAK)



Dimensions	Value (in mm)		
С	5.08		
Х	1.10		
X1	10.41		
Y	3.50		
Y1	7.01		
Y2	15.99		



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